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ULQ2801 - ULQ2802 ULQ2803 - ULQ2804

Eight Darlington array

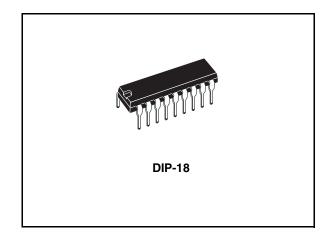
Features

- Eight Darlingtons per package
- Extended temperature range: -40 to 105 °C
- Output current to 500 mA
- Output voltage to 50 V
- Integral suppression diodes
- Versions for all popular logic families
- Output can be paralleled
- Inputs pinned opposite outputs to simplify board layout

Description

The ULQ2801A-ULQ2804A each contain eight Darlington transistors with common emitters and integral suppression diodes for inductive loads. Each Darlington features a peak load current rating of 600 mA (500 mA continuous) and can withstand at least 50 V in the off state. Outputs may be paralleled for higher current capability.

Five versions are available to simplify interfacing to standard logic families: the ULQ2801A is



designed for general purpose applications with a current limit resistor; the ULQ2802A has a 10.5 k Ω input resistor and zener for 14-25V PMOS; the ULQ2803A has a 2.7 k Ω input resistor for 5 V TTL and CMOS; the ULQ2804A has a 10.5 k Ω input resistor for 6-15 V CMOS.

All types are supplied in a 18-lead plastic DIP with a copper lead from and feature the convenient input-opposite-output pinout to simplify board layout.

Table 1. Device summary

Order codes	Package
ULQ2801A	DIP-18
ULQ2802A	DIP-18
ULQ2803A	DIP-18
ULQ2804A	DIP-18

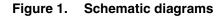
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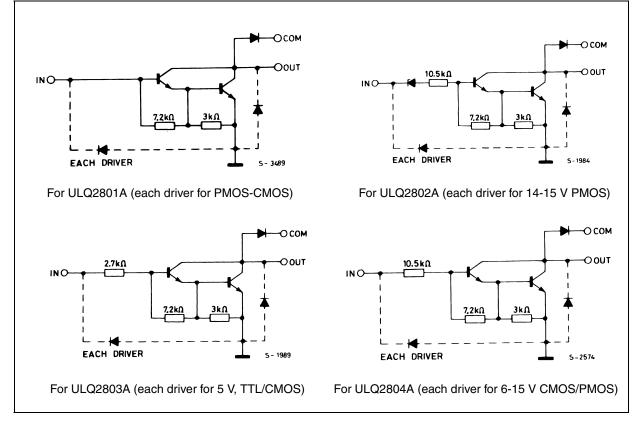
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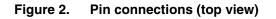


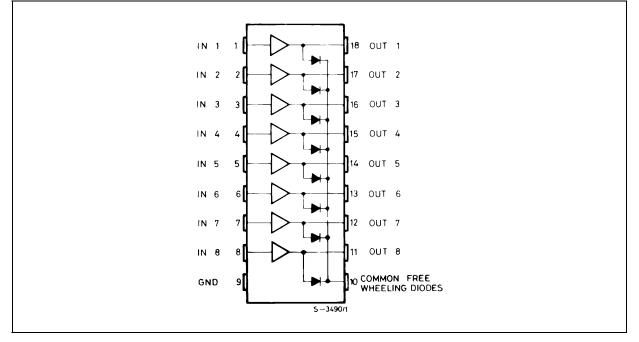
1 Diagrams





2 Pin configuration







3 Maximum ratings

Table 2.	Absolute maximum ratings
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Symbol	Parameter	Value	Unit
V _O	Output voltage	50	V
V _I	Input voltage (for ULQ2802A - ULQ2803A - ULQ2804A)	30	V
Ι _C	Continuous collector current	500	mA
Ι _Β	Continuous base current	25	mA
P	Power dissipation (one Darlington pair)		W
FTOT	P _{TOT} Power dissipation (total package)		vv
T _A	Operating ambient temperature range	- 40 to 85	°C
T _{STG}	Storage temperature range	- 55 to 150	°C

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thJA}	Thermal resistance junction-ambient, Max.	55	°C/W



4 **Electrical characteristics**

Table 4.Electrical characteristics

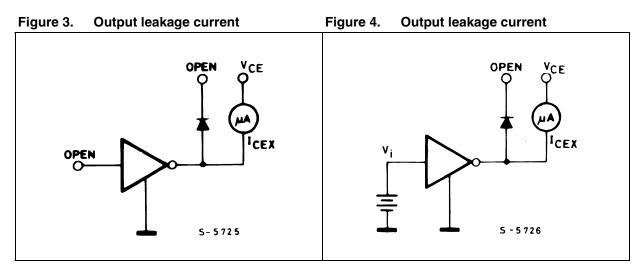
(T_A = 25 °C unless otherwise specified).

Symbol	Parameter	Test condition	Min.	Тур.	Max.	Unit
		V _{CE} = 50V, (<i>Figure 7</i>)			50	
I _{CEX} Output leakage current		T _A = 105°C, V _{CE} = 50V (<i>Figure 7</i>)			100	
	$T_A = 105^{\circ}C$ for ULQ2802A, $V_{CE}=50V$, $V_I = 6V$ (<i>Figure 8</i>)			500	μA	
		$T_A = 105^{\circ}C$ for ULQ2804A, $V_{CE}=50V$, $V_I = 1V$ (<i>Figure 8</i>)			500	
		$I_{\rm C} = 100 {\rm mA}, I_{\rm B} = 250 {\mu}{\rm A}$		0.9	1.1	
$V_{CE(SAT)}$	Collector-emitter saturation voltage (<i>Figure 9</i>)	I _C = 200mA, I _B = 350μA		1.1	1.3	V
	Vollago (<i>rigulo o</i>)	I _C = 350mA, I _B = 500μA		1.3	1.6	
		for ULQ2802A, V _I = 17V		0.82	1.25	
		for ULQ2803A, V _I = 3.85V		0.93	1.35	
I _{I(ON)}	Input current (<i>Figure 6</i>)	for ULQ2804A, $V_1 = 5V$		0.35	0.5	mA
		V ₁ = 12V		1	1.45	
I _{I(OFF)}	Input current (Figure 7)	$T_{A} = 105^{\circ}C, I_{C} = 500\mu A$	50	65		μA
V _{I(ON)}	Input voltage (<i>Figure 8</i>)	$\label{eq:VcE} \begin{array}{l} V_{CE} = 2V \text{, for ULQ2802A} \\ I_{C} = 300\text{mA} \\ \text{for ULQ2803A} \\ I_{C} = 200\text{mA} \\ I_{C} = 250\text{mA} \\ I_{C} = 300\text{mA} \\ \text{for ULQ2804A} \\ I_{C} = 125\text{mA} \\ I_{C} = 200\text{mA} \\ I_{C} = 275\text{mA} \\ I_{C} = 350\text{mA} \end{array}$			13 2.4 2.7 3 5 6 7 8	V
h _{FE}	DC forward current gain (<i>Figure 5</i>)	for ULQ2801A, $V_{CE} = 2V$, $I_C = 350$ mA	1000			
CI	Input capacitance			15	25 ⁽¹⁾	pF
t _{PLH}	Turn-on delay time	0.5 V _I to 0.5V _O		0.25	1 ⁽¹⁾	μs
t _{PHL}	Turn-off delay time	0.5 V _I to 0.5V _O		0.25	1 ⁽¹⁾	μs
	Clamp diode leakage current	V _R = 50V			50	μA
I _R	(Figure 9)	T _A = 105°C, V _R = 50V			100	μ-
V _F	Clamp diode forward voltage (<i>Figure 10</i>)	I _F = 350mA		1.7	2	V

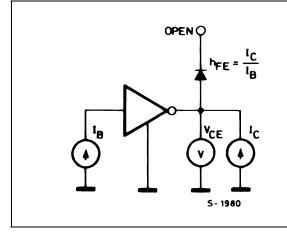
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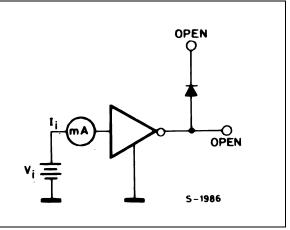


5 Test circuits











gure 8. Input voltage

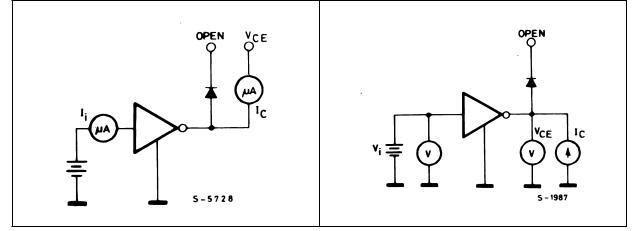
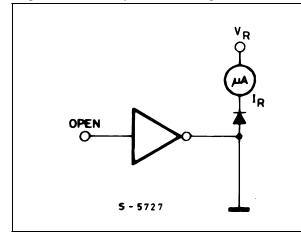
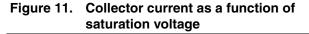


Figure 9. Clamp diode leakage current

Figure 10. Clamp diode forward voltage





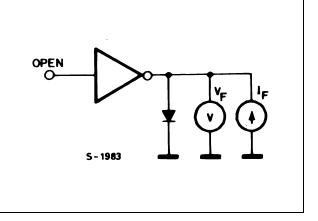


Figure 12. Collector current as a function of input current

l_c (mA

400

200

0

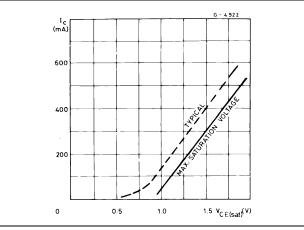


Figure 13. Allowable average power dissipation as a function of T_A

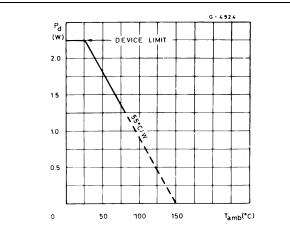


Figure 14. Peak collector current as a function of duty cycle

200

MAX REQUIRED

1_i (μΑ)

57

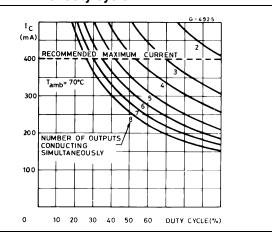


Figure 15. Peak collector current as a function Figure 16. Input current as a function of input voltage (for ULQ2802A) of duty

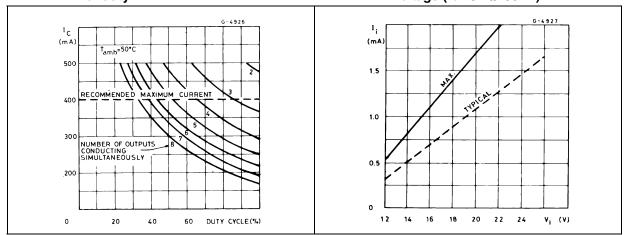
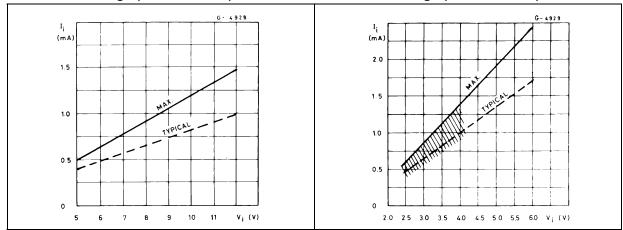


Figure 17. Input current as a function of input Figure 18. Input current as a function of input voltage (for ULQ2804A)

voltage (for ULQ2803A)



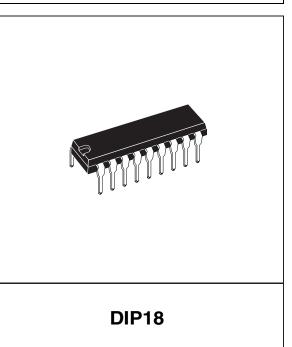
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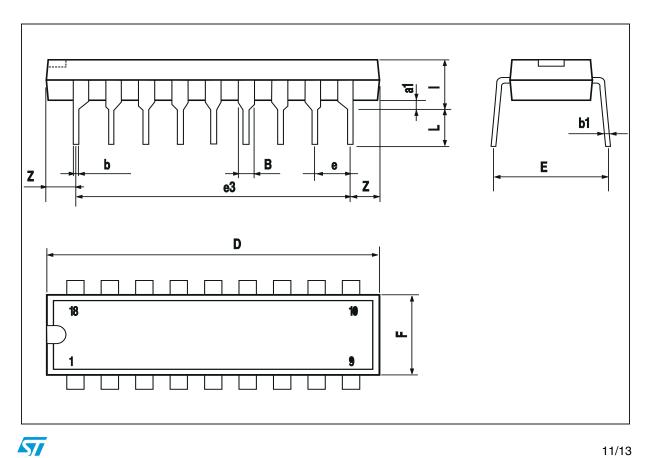
6 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK[®] packages. These packages have a lead-free second level interconnect. The category of second Level Interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

DIM.	mm		inch			
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
a1	0.254			0.010		
В	1.39		1.65	0.055		0.065
b		0.46			0.018	
b1		0.25			0.010	
D			23.24			0.915
E		8.5			0.335	
е		2.54			0.100	
e3		20.32			0.800	
F			7.1			0.280
Ι			3.93			0.155
L		3.3			0.130	
Z		1.27	1.59		0.050	0.063

OUTLINE AND MECHANICAL DATA





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7 Revision history

Table 5.	Document revision history
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Date	Revision	Changes	
19-Sep-2003	1	First issue.	
25-Jun-2008	2	Added: Table 1 on page 1.	

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